



NEW T-CLAD® PA STICKS IT TO HEAT.

Peel and place thermal solution withstands the heat of solder reflow.



Thermally conductive insulated metal substrate boards specifically configured for LED applications.

Easier assembly, cooler LEDs.

Bergquist's T-Clad with pre-applied Bond-Ply® 450 allows you to adhere your mounted LEDs to a variety of heatsinks and surfaces while thermally optimizing your application. This version of peel and place T-Clad can withstand the high temperatures of solder reflow during LED assembly and then be positioned in the lighting application using its strong thermally conductive adhesive.

Call or visit to qualify for your FREE sample.



FREE T-Clad® PA
Sample Board

Call **1.800.347.4572** or visit **www.bergquistcompany.com/preapplied**



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